EAST Search History

EAST Search History (Prior Art)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	"US 20050190824"	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2009/07/31 09:04
L3	22	"5799069"	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2009/07/31 09:10
L4	2	("5799069").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/07/31 09:10
L5	3	("4008427").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/07/31 09:11
L6	2	("6624635").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/07/31 09:12
L7	2	("5290970").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/07/31 09:33
L8	2	("6519339").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/07/31 09:36
L9	3428	375/222.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/07/31 09:41
L10	113	9 and tip near ring and Modem	USPAT	OR	ON	2009/07/31 09:41
L11	24	10 and ("carrier assembly" or "motherboard" or "printed circuit board")	USPAT	OR	ON	2009/07/31 09:42

L12	2	("5737397").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/07/31 09:47
L13	25	("3991288" | "4543450" | "4620294" | "4788717" | "4868863" | "5134648" | "5245654" | "5283638" | "5408520" | "5457601").PN. OR ("5737397").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2009/07/31 10:49
L14	64	"5,984,731"	US-PGPUB; USPAT; USOCR	OR	ON	2009/07/31 10:57
L15	2	("5,984,731").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/07/31 10:57
L16	12	10 and motherboard	USPAT	OR	ON	2009/07/31 11:06
L21	0	motherboard and modem and solder adj pad and tip near ring and Modem	USPAT	OR	ON	2009/07/31 11:12
L22	0	motherboard and modem and solder adj pad and tip near ring	USPAT	OR	ON	2009/07/31 11:12
L23	5	modem and solder adj pad and tip near ring	USPAT	OR	ON	2009/07/31 11:12
L24	2	("5984731").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/07/31 11:18
L25	86	("4103985" | "4242721" | "4303296" | "5183404" | "5244397" | "5336099" | "5338210" | "5386340" | "5391083" | "5391094" | "5395268" | "5411405" | "5457601" | "5477418" | "5499923" | "5505628" | "5505633" | "5509811" | "5532898" | "5538442" | "5547401" | "5548483" | "5561727" | "5562463" | "5562501" | "5608606" | "5608607" | "5611055" | "5619396" | "5628055" | "5634802" | "5637018" | "5702271" | "5773332" | "5775946").PN. OR ("5984731").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2009/07/31 11:20
L26	11	"6320252"	US-PGPUB; USPAT; USOCR	OR	ON	2009/07/31 11:34
L27	2	("6320252").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/07/31 11:34

S1	967	361/777.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/16 15:53
S2	16	APPARATUS near MOUNTING and MODEM and CARRIER near ASSEMBLY	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/16 15:53
S4	2	S2 and solder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/16 15:54
S5	0	("2005/0190824").URPN.	USPAT	OR	ON	2008/08/16 16:04
S6	120059	("carrier assembly" or "motherboard" or "printed circuit board")	USPAT	OR	ON	2008/08/16 16:14
S7	93	S6 and modem and solder adj pads	USPAT	OR	ON	2008/08/16 16:15
S8	62	S6 and "tip/ring"	USPAT	OR	ON	2008/08/16 16:16
S9	314192	S8 and sold$4 pads	USPAT	OR	ON	2008/08/16 16:16
S10	0	S8 and sold$4 near pads	USPAT	OR	ON	2008/08/16 16:17
S11	1	S8 and sold$4 and pads	USPAT	OR	ON	2008/08/16 16:17
S12	0	S8 and sold$4 same pads	USPAT	OR	ON	2008/08/16 16:17
S13	24	("carrier assembly" or "motherboard" or "printed circuit board") and ("solder pads" or pads or soldering) and ("tip/ring")	USPAT	OR	ON	2008/08/16 16:19
S14	0	("carrier assembly" or "motherboard" or "printed circuit board") and ("solder pads" or pads or soldering) and ("tip/ring")and ("modem") and ("telephone Line" or "signal line")	USPAT	OR	ON	2008/08/16 16:21
S15	18	("carrier assembly" or "motherboard" or "printed circuit board") and ("solder pads" or pads or soldering) and ("tip/ring")and ("Modem")	USPAT	OR	ON	2008/08/16 16:23
S16	18	("carrier assembly" or "motherboard" or "printed circuit board") and ("tip/ring") and ("Modem")and ("solder pads" or pads or soldering)	USPAT	OR	ON	2008/08/16 16:25
S17	0	("carrier assembly" or "motherboard" or "printed circuit board") and ("tip near ring")and ("Modem")	USPAT	OR	ON	2008/08/16 16:31
S18	120059	("carrier assembly" or "motherboard" or "printed circuit board")	USPAT	OR	ON	2008/08/16 16:32

S19	258	S18 and tip near ring and Modem	USPAT	OR	ON	2008/08/16 16:33
S20	5	S19 and solder adj pads	USPAT	OR	ON	2008/08/16 16:33
S21	63	S19 and pads	USPAT	OR	ON	2008/08/16 16:37
S22	31	S21 and telephone adj line	USPAT	OR	ON	2008/08/16 16:38
S23	8	S22 and IC	USPAT	OR	ON	2008/08/16 16:39
S24	15	S22 and ("IC" or "integrated circuit")	USPAT	OR	ON	2008/08/16 16:40
S25	0	"method for fabricating a modem module"	USPAT	OR	ON	2008/08/17 15:30
S26	0	"method fabricating a modem module"	USPAT	OR	ON	2008/08/17 15:30
S27	0	method near fabrica$3 near3 modem adj module	USPAT	OR	ON	2008/08/17 15:31
S28	0	fabrica$3 near3 modem adj module	USPAT	OR	ON	2008/08/17 15:31
S29	0	("fabrica$3near3modemadjmodule"). PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/17 15:31
S30	86	fabrica$3 near3 modem	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/17 15:32
S31	34	method and S30	USPAT	OR	ON	2008/08/17 15:32
S32	6	S31 and("carrier assembly" or "motherboard" or "printed circuit board")	USPAT	OR	ON	2008/08/17 15:32
S33	3	("3,704,347").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/17 15:33
S34	10	"3,704,347"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/17 15:34
S35	2120	("carrier assembly" or "motherboard" or "printed circuit board") and Modem and circui$4 and pads	USPAT	OR	ON	2008/08/17 16:23
S36	8552	("carrier assembly" or "motherboard" or "printed circuit board") and Modem and circui$4 and padsand interfac$3 with telephone adj line	USPAT	OR	ON	2008/08/17 16:25

S37	113	("carrier assembly" or "motherboard" or "printed circuit board") and Modem and circui$4 and padsand interfac$3 with telephone adj line and "tip/ring"	USPAT	OR	ON	2008/08/17 16:25
S38	1	("carrier assembly" or "motherboard" or "printed circuit board") and Modem and circui$4 and padsand interfac$3 with telephone adj line and "tip/ring" and motherboard	USPAT	OR	ON	2008/08/17 16:25
S39	16	("5384808" | "5654984" | "5737397" | "6067583" | "6122216" | "6169475" | "6169801" | "6173405" | "6182893" | "6212263" | "6285706" | "6351530" | "6401152" | "6427011" | "6697464" | "6876742").PN. OR ("7330544").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/08/17 16:27
S40	4	"6876742"	US-PGPUB; USPAT; USOCR	OR	ON	2008/08/17 16:33
S41	2	("6876742").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/17 16:33
S42	2	("5654984").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/17 16:52
S43	2	("20040095719").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/18 10:56
S44	2	("20030169567").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/18 10:57
S45	2	("6888725").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/18 10:57
S46	2	("20020159237").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/18 10:58

S47	24	APPARATUS near MOUNTING and MODEM and MOTHERBOARD	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 12:04
S48	6	APPARATUS near MOUNTING and MODEM and MOTHERBOARD and solder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 12:05
S49	4	MOUNTING and MODEM and MOTHERBOARD and solder and carrier adj assembly	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 12:11
S50	5	modem adj circuitry and modem adj module and motherboard and pads	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 12:14
S51	2	modem adj circuitry and modem and motherboard and solder adj pads	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 12:38
S52	1034	"modem module"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 12:47
S53	22	S52 and circuitry and solder adj pads	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 12:48
S54	22	S53 and telephone adj line	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 12:49
S55	1	S54 and carrier adj assembly	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 12:50

S56	22	S54 and assembly	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 12:50
S57	22	S56 and interfacing with telephone	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 12:51
S58	22	S57 and printed adj circuit adj board	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 12:53
S59	22	S57 and printed adj circuit adj board and connect$3 near4 modem	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 12:53
S60	2	("2003/0105948").URPN.	USPAT	OR	ON	2009/01/29 13:02
S61	11	("mounting modem")	USPAT	OR	ON	2009/01/29 13:15
S62	1	S61 and pads	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 13:16
S63	14	("4602842" | "4695112" | "4781626" | "5387132" | "5468920" | "5692910" | "5709555").PN. OR ("6379193").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2009/01/29 13:20
S64	2371	printed adj circuit adj board and connect$3 near4 modem	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 13:24
S65	2047	motherboard and connect$3 near4 modem	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 13:28
S66	9	S65 and solder adj pads	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 13:28

S67	47	modem near4 mounted near5 motherboard	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 13:34
S68	47	modem near4 mounted near5 motherboard	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 13:35
S69	13658	S68 aand solder adj pads	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 13:35
S70	2	S68 and solder adj pads	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 13:35
S71	1976	375/222.ccls.	USPAT	OR	ON	2009/01/29 13:36
S72	0	S71 and modem adj circuitry and modem and motherboard and solder adj pads	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 13:36
S73	83	S71 and modem adj circuitry and modem	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 13:37
S74	896458	S71 and modem adj circuitry and modem and solder pads	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 13:37
S75	0	S71 and modem adj circuitry and modem and solder adj pads	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 13:37
S76	0	S71 and modem adj circuitry and modem and solder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 13:37

S77	3	S71 and modem adj circuitry and modem and pads	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 13:37
S78	99	("4939623" | "5038250" | "5161169"). PN. OR ("5457601").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2009/01/29 13:55
S79	64	"5,984,731"	US-PGPUB; USPAT; USOCR	OR	ON	2009/01/29 14:00
S80	2	("5,984,731").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/29 14:00
S81	2	("6,078,661").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/29 14:22

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